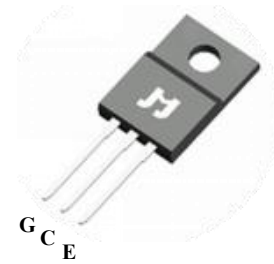


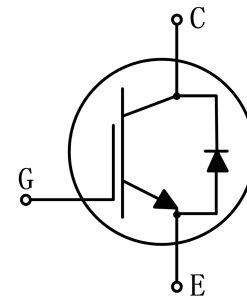
Key performance:

- $V_{CE}=650V$
- $I_C=15A@T_C=100^{\circ}C$
- $V_{CE(sat)}=1.7V$

TO-220F


Features:

- High ruggedness performance.
- Positive $V_{CE(sat)}$ temperature coefficient.
- High efficiency for motor control.
- Excellent current sharing in parallel operation.
- RoHS compliant.


Applications:

- Energy storage

Package parameters

Type	Marking	Package	Packaging method
JJT15N65HS	T1565HS	TO-220F	Tube

Maximum ratings

Symbol	Parameter	Values	Unit
V_{CES}	Collector-emitter voltage	650	V
V_{GES}	Gate-emitter voltage	±20	V
I_C	Continuous collector current ($T_C=25^\circ\text{C}$)	30	A
	Continuous collector current ($T_C=100^\circ\text{C}$)	15	A
I_{CM}	Pulsed collector current, t_p limited by T_{vjmax}	60	A
I_F	Diode continuous forward current ($T_C=100^\circ\text{C}$)	15	A
I_{FM}	Diode maximum current, t_p limited by T_{vjmax}	60	A
P_{tot}	Power dissipation ($T_C=25^\circ\text{C}$)	71	W
	Power dissipation ($T_C=100^\circ\text{C}$)	36	W
T_{vj}	Operating junction temperature range	-40 to +175	°C
T_{stg}	Storage temperature range	-55 to +150	°C

Thermal characteristics

Symbol	Parameter	Values		Unit
		Typ.	Max.	
$R_{th(j-c)}$	Thermal resistance, junction to case for IGBT	-	2.1	K/ W
$R_{th(j-c)}$	Thermal resistance, junction to case for Diode	-	3.2	K/ W
$R_{th(j-a)}$	Thermal resistance, junction to ambient	-	70	K/ W

Electrical characteristics of IGBT ($T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)

Static characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
BV_{CES}	Collector-emitter breakdown voltage	$V_{GE}=0\text{V}, I_C=250\mu\text{A}$	650	-	-	V
I_{CES}	Collector-emitter leakage current	$V_{CE}=650\text{V}, V_{GE}=0\text{V}$	-	-	50	μA
I_{GES}	Gate leakage current, forward	$V_{GE}=20\text{V}, V_{CE}=0\text{V}$	-	-	100	nA
	Gate leakage current, reverse	$V_{GE}=-20\text{V}, V_{CE}=0\text{V}$	-	-	-100	nA
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{GE}=V_{CE}, I_C=1\text{mA}$	5.3	5.8	6.3	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE}=15\text{V}, I_C=15\text{A}$	-	1.7	-	V
		$V_{GE}=15\text{V}, I_C=15\text{A}, T_{vj}=175^{\circ}\text{C}$	-	2.1	-	V

Dynamic characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
C_{ies}	Input capacitance	$V_{CE}=30\text{V}$ $V_{GE}=0\text{V}$ $f=1\text{MHz}$	-	1055	-	pF
C_{oes}	Output capacitance		-	57	-	pF
C_{res}	Reverse transfer capacitance		-	15	-	pF
Q_g	Total gate charge	$V_{CC}=520\text{V}$ $V_{GE}=15\text{V}$ $I_C=15\text{A}$	-	55	-	nC

Switching characteristics

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
$t_{d(on)}$	Turn-on delay time	$V_{CC}=400V$ $V_{GE}=0/15V$ $I_C=15A$ $R_G=10\Omega$ Inductive load	-	17	-	ns
t_r	Rise time		-	14	-	ns
$t_{d(off)}$	Turn-off delay time		-	104	-	ns
t_f	Fall time		-	41	-	ns
E_{on}	Turn-on energy		-	0.42	-	mJ
E_{off}	Turn-off energy		-	0.30	-	mJ
E_{ts}	Total switching energy		-	0.72	-	mJ
$t_{d(on)}$	Turn-on delay time	$V_{CC}=400V$ $V_{GE}=0/15V$ $I_C=15A$ $R_G=10\Omega$ Inductive load $T_{vj}=175^\circ C$	-	17	-	ns
t_r	Rise time		-	15	-	ns
$t_{d(off)}$	Turn-off delay time		-	123	-	ns
t_f	Fall time		-	77	-	ns
E_{on}	Turn-on energy		-	0.48	-	mJ
E_{off}	Turn-off energy		-	0.45	-	mJ
E_{ts}	Total switching energy		-	0.93	-	mJ

Electrical characteristics of Diode ($T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test condition	Values			Unit
			Min.	Typ.	Max.	
V_F	Diode forward voltage	$I_F=15\text{A}$	-	1.4	-	V
		$I_F=15\text{A}, T_{vj}=175^{\circ}\text{C}$	-	1.2	-	V
t_{rr}	Diode reverse recovery time	$V_R=400\text{V}$ $I_F=15\text{A}$ $di_F/dt=-600\text{A}/\mu\text{s}$	-	55	-	ns
I_{rrm}	Diode peak reverse recovery current		-	9.5	-	A
Q_{rr}	Diode reverse recovery charge		-	220	-	nC
t_{rr}	Diode reverse recovery time	$V_R=400\text{V}$ $I_F=15\text{A}$ $di_F/dt=-600\text{A}/\mu\text{s}$ $T_{vj}=175^{\circ}\text{C}$	-	77	-	ns
I_{rrm}	Diode peak reverse recovery current		-	15	-	A
Q_{rr}	Diode reverse recovery charge		-	481	-	nC

Typical performance characteristics

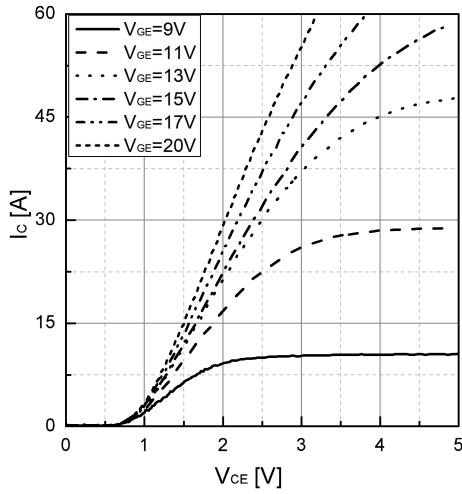


Fig 1. Typical output characteristic ($T_{vj}=25^{\circ}\text{C}$)

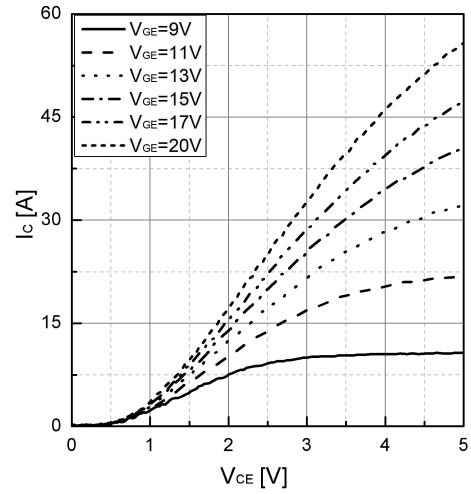


Fig 2. Typical output characteristic ($T_{vj}=175^{\circ}\text{C}$)

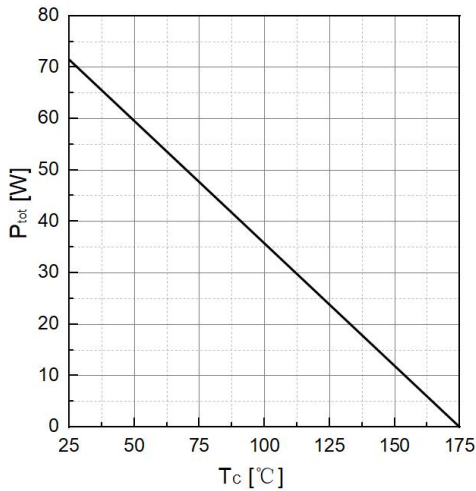


Fig 3. Power dissipation as a function of T_c

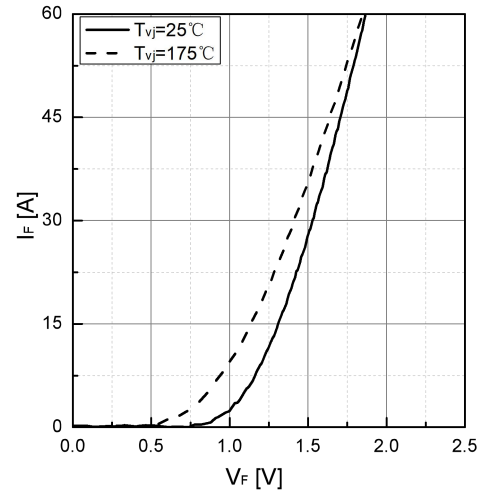


Fig 4. Typical I_F as a function of V_F

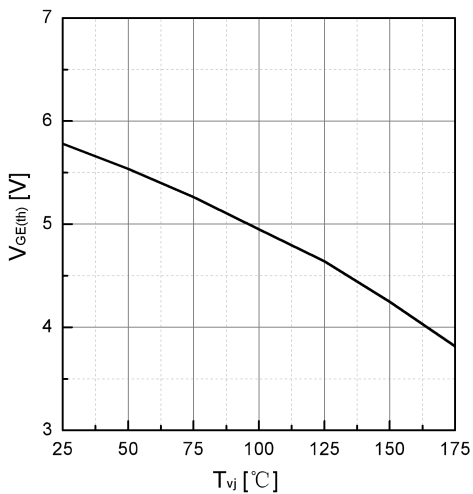


Fig 5. Typical $V_{GE(th)}$ as a function of T_{vj}
($I_C=1\text{mA}$)

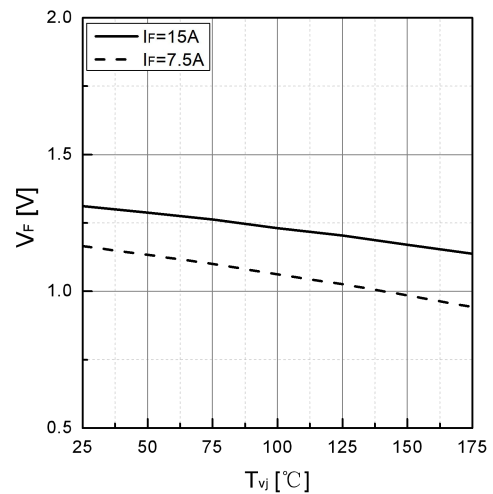


Fig 6. Typical V_F as a function of T_{vj}

Typical performance characteristics

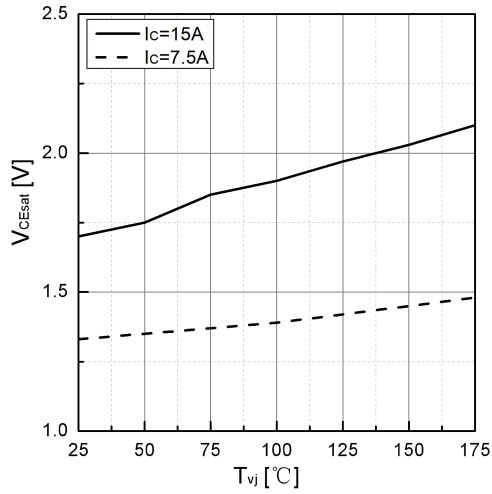


Fig 7. Typical V_{CEsat} as a function of T_{vj}

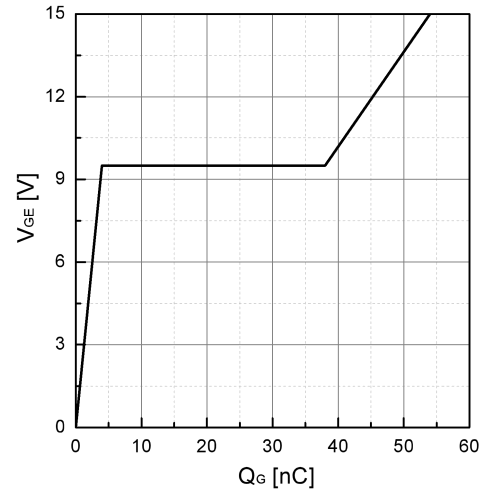


Fig 8. Typical Gate charge

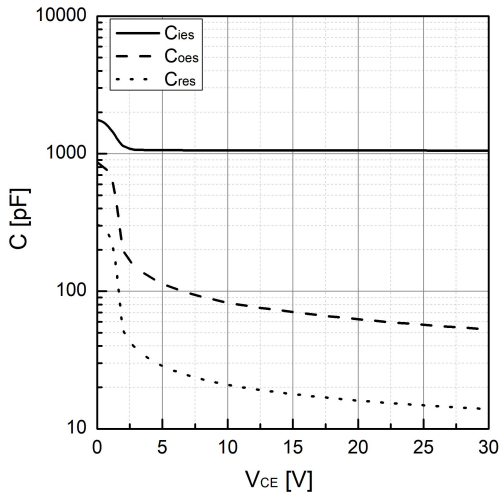


Fig 9. Typical capacitance as a function of V_{CE}
($f=1\text{MHz}$, $V_{GE}=0\text{V}$)

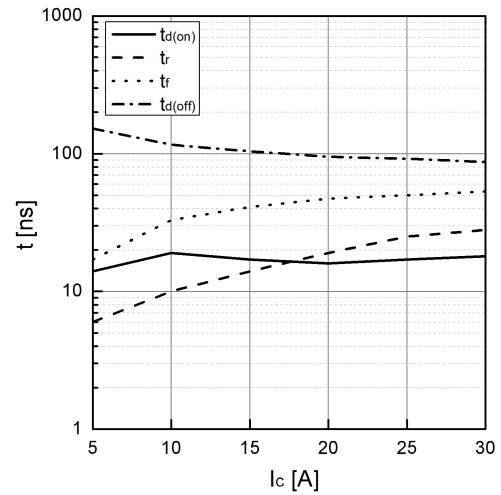


Fig 10. Typical switching times as a function of I_c

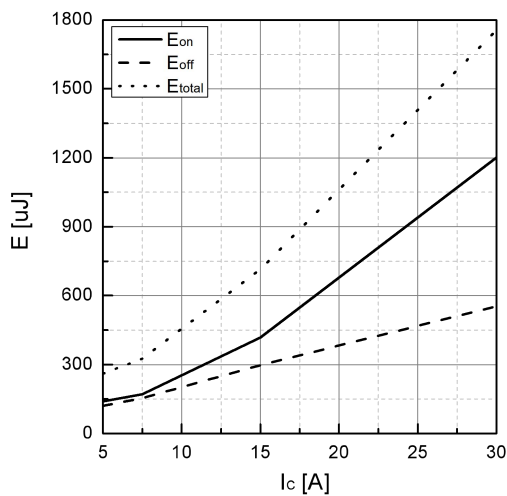


Fig 11. Typical switching energy losses as a function of I_c

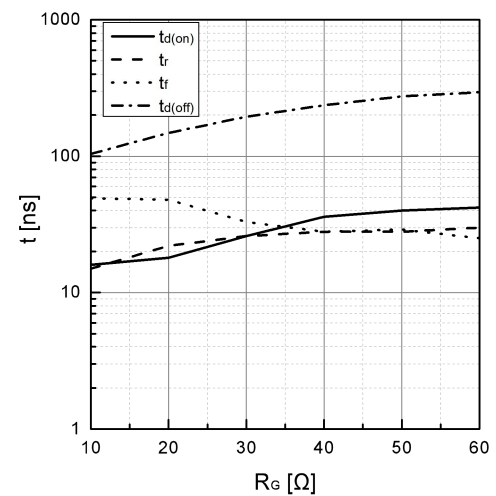


Fig 12. Typical switching times as a function of R_G

Typical performance characteristics

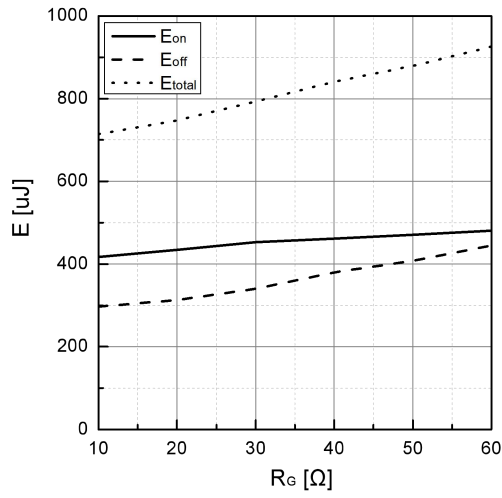


Fig 13. Typical switching energy losses as a function of R_G

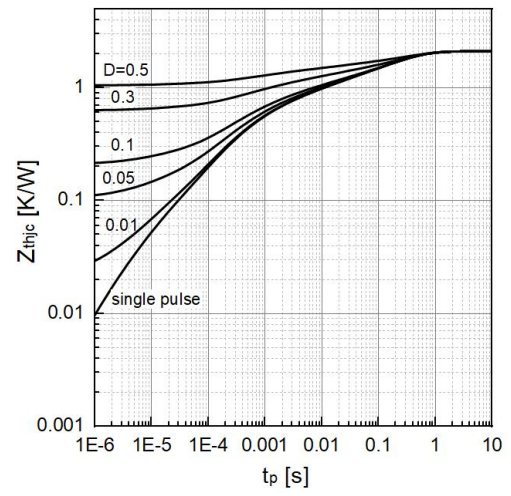
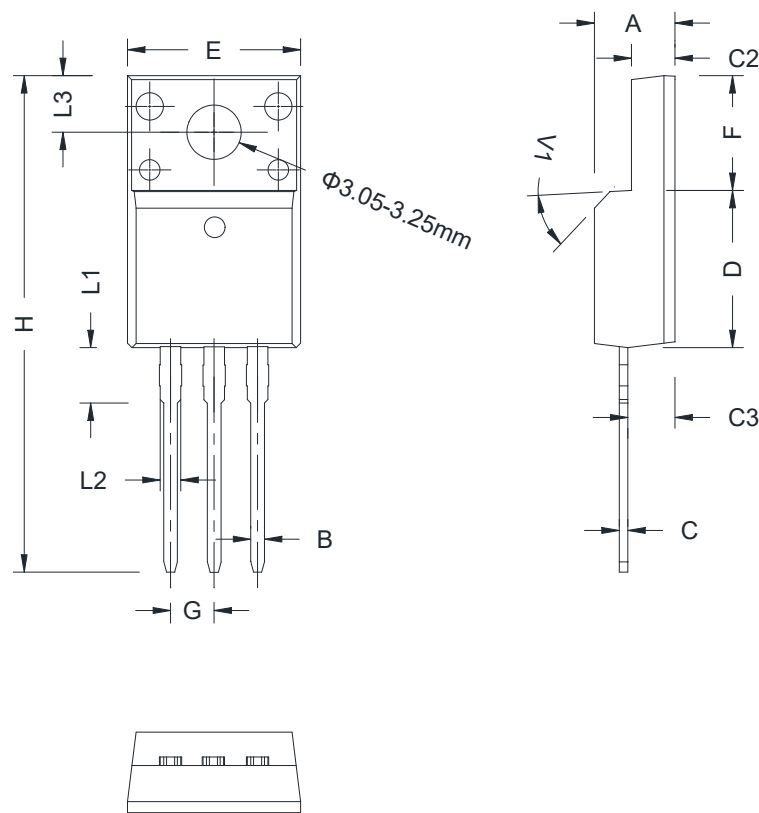


Fig 14. Transient thermal impedance, IGBT

Package dimension

TO-220F



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.50	-	4.90	0.177	-	0.193
B	0.74	0.80	0.83	0.029	0.031	0.033
C	0.47	-	0.66	0.019	-	0.026
C2	2.45	-	2.75	0.096	-	0.108
C3	2.60	-	3.00	0.102	-	0.118
D	8.80	-	9.30	0.346	-	0.366
E	9.80	-	10.40	0.386	-	0.410
F	6.40	-	6.80	0.252	-	0.268
G	2.40	-	2.70	0.094	-	0.106
H	28.0	-	29.80	1.102	-	1.173
L1	-	3.63	-	-	0.143	-
L2	1.14	-	1.70	0.045	-	0.067
L3	-	3.30	-	-	0.130	-
V1	-	45°	-	-	45°	-

Revision history

Date	Revision	Changes
2025-04-30	Rev 1.0	Release of the datasheet
2026-06-24	Rev 1.1	Update thermal

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